

Material: 3879817

Hyper pure Silicon Wafers (polished, epitaxial and non polished)

Version: 1.6 (IE)

11

Date of print: 20.08.2020

Date of last alteration: 19.08.2020

SECTION 1: Identification of the substance/mixture and of the company/undertaking

Product identifier Hyper pure Silicon Wafers Commercial product name: (polished, epitaxial and non polished) 7440-21-3 CAS No .: EC-No.: 231-130-8 **REACH** registration number: 01-2119480401-47-0220 1.2 Relevant identified uses of the substance or mixture and uses advised against Use of substance / preparation: Industrial. electronic 1.3 Details of the supplier of the safety data sheet Manufacturer/distributor: Siltronic AG Street/POB-No .: Johannes-Hess-Straße 24 State/postal code/city: D 84489 Burghausen Telephone: +49 8677 83-3930 +49 8677 83-62171 Telefax: Information about the Safety Data Sheet: Telephone +49 8677 83-4888 Telefax +49 8677 886-9722 eMail WLCP-MSDS@wacker.com

1.4 **Emergency telephone number**

Emergency Information (German): Emergency Information (internat.):

Plant fire brigade National Response Center

+49 8677 83-2222

+49 621 60-43333

SECTION 2: Hazards identification

Classification of the substance or mixture 2.1

Classification according to Regulation (EC) No. 1272/2008: Not a hazardous substance or mixture.

Label elements 2.2

Labelling according to Regulation (EC) No. 1272/2008: No labeling according to GHS required.

EC-No.: 231-130-8

2.3 Other hazards

No data available.

SECTION 3: Composition/information on ingredients

31 Substances

3.1.1 Chemical characteristics

CAS No.: 7440-21-3 Silicon

3.1.2 Hazardous ingredients



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	This material does not contain a	any ingredients above the permitted limit(s).		
	This product does not contain s above ≥ 0.1%.	ubstances of very high concern (Regulation (EC) No 1	907/2006 (REACH), Article 57) in amounts	
3.2	Mixtures			
	not applicable			
SEC	CTION 4: First aid measure	95		
4.1	Description of first aid measu	res		
I	General information: No special measures required.			
I	After contact with the eyes: Rinse immediately with plenty of water for 10-15 minutes and seek medical advice.			
I	After contact with the skin: No special measures required.			
I	After inhalation: In case of dust formation: Provide fresh air.			
I	After swallowing: No special measures required. In cases of sickness seek medical advice (show label if possible).			
4.2	Most important symptoms an	d effects, both acute and delayed		
	Any relevant information can be	found in other parts of this section.		
4.3 Indication of any immediate medical attention and special treatment needed				
	Further toxicology information ir	a section 11 must be observed.		
SEC	CTION 5: Firefighting meas	sures		
5.1	Extinguishing media			
	Suitable extinguishing media			
	Use extinguishing measures ap			
I	Extinguishing media which m not applicable	ust not be used for safety reasons:		
5.2	Special hazards arising from	the substance or mixture		
	Hazardous combustion products	s: silicon dioxide .		
5.3	Advice for firefighters			
I	Special protective equipment for fire fighting: Use respiratory protection independent of recirculated air. Use tightly fitting chemical protection suit (see section 8).			
SEC	TION 6: Accidental releas	e measures		
6.1	Personal precautions, protect	tive equipment and emergency procedures		
I	Wear personal protection equipment (see section 8).			
6.2	Environmental precautions	· · · ·		
I	Observe local/state/federal regu	llations.		
6.3	Methods and material for con			

Take up mechanically and dispose of according to local/state/federal regulations.



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6.4 Reference to other sections

Relevant information in other sections has to be considered. This applies in particular for information given on personal protective equipment (section 8) and on disposal (section 13).

SECTION 7: Handling and storage

7.1 Precautions for safe handling

Precautions for safe handling:

Keep container closed when not in use. Keep away from incompatible substances in accordance with section 10.

Precautions against fire and explosion:

Observe the general rules for fire prevention. Product can separate hydrogen in contact with lyes.

7.2 Conditions for safe storage, including any incompatibilities

Conditions for storage rooms and vessels:

Observe local/state/federal regulations. Protect against moisture.

- Advice for storage of incompatible materials:
- Keep away from alkalis. Avoid contact with acids.

Further information for storage:

Protect against moisture.

7.3 Specific end use(s)

No data available.

SECTION 8: Exposure controls/personal protection

8.1 Control parameters

Maximum airborne concentrations at the workplace: not applicable

Predicted No Effect Concentration (PNEC):

silicon			
Area of use:	Value:		
Intermittent release	100 mg/l		
sewage treatment plant	25 mg/l		

8.2 Exposure controls

8.2.1 Exposure in the work place limited and controlled

General protection and hygiene measures:

Observe standard industrial hygiene practices for the handling of chemical substances. Avoid contact with eyes and skin. Do not eat, drink or smoke when handling. Wash hands at the end of work and before eating.

Personal protection equipment:

Respiratory protection

No personal respiratory protective equipment normally required.

Respirator must be worn if exposed to dust. Suitable respiratory equipment: Filtering half-face mask, according to acknowledged standards such as EN 149.

Recommended Filter type: FFP1 or equivalent filter, according to acknowledged standards such as EN 149

Eye protection

In case of mechanical handling: tight fitting protective goggles .

Hand protection



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Use of protective gloves is recommended when handling the material. For the choice of suitable gloves, workplace conditions have to be considered, like e.g. handling of other substances and materials. Recommended glove types: Protective gloves, non-cuttable Skin protection Recommendation in case of dust formation: protective clothing . SECTION 9: Physical and chemical properties Information on basic physical and chemical properties 9.1 Property: Value: Method: Appearance Physical state: solid Form: compact Colour.....: silver Odour Odour.....: odourless **Odour limit** Odour limit no data available pH-Value pH-Value not applicable Melting point/freezing point Melting point / melting range..... 1410 °C Initial boiling point and boiling range Boiling point / boiling range..... 2355 °C Flash point Flash point..... not applicable Evaporation rate Evaporation rate no data available Upper/lower flammability or explosive limits Lower explosion limit (LEL)..... not applicable Upper explosion limit (UEL) not applicable Vapour pressure Vapour pressure not applicable Solubility(ies) Water solubility / miscibility virtually insoluble Vapour density Relative gas/vapour density No data known. **Relative Density** Relative Density 2.32 (Water / 4 °C = 1.00)Density 2,32 g/cm³ Partition coefficient: n-octanol/water Partition coefficient: n-octanol/water.....: No data known. Auto-ignition temperature Ignition temperature..... not applicable Viscosity Viscosity (dynamic)..... not applicable Viscosity (kinematic)..... not applicable Molecular mass Molecular mass..... no data available 9.2 Other information

No data available.



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SECTION 10: Stability and reactivity

10.1 - 10.3 Reactivity; Chemical stability; Possibility of hazardous reactions

If stored and handled in accordance with standard industrial practices no hazardous reactions are known.

Relevant information can possibly be found in other parts of this section.

10.4 Conditions to avoid

Moisture.

10.5 Incompatible materials

Reacts with: lyes . The reaction takes place with the formation of hydrogen. Reacts with: strong oxidizing agents , acids .

10.6 Hazardous decomposition products

If stored and handled properly: none known.

SECTION 11: Toxicological information

11.1 Information on toxicological effects

11.1.1 Acute toxicity

Assessment:

For this endpoint no toxicological test data is available for the whole product.

11.1.2 Skin corrosion/irritation

Assessment:

For this endpoint no toxicological test data is available for the whole product.

11.1.3 Serious eye damage / eye irritation

Assessment:

For this endpoint no toxicological test data is available for the whole product.

11.1.4 Respiratory or skin sensitization

Assessment:

For this endpoint no toxicological test data is available for the whole product.

11.1.5 Germ cell mutagenicity

Assessment:

For this endpoint no toxicological test data is available for the whole product.

11.1.6 Carcinogenicity

Assessment:

For this endpoint no toxicological test data is available for the whole product.

11.1.7 Reproductive toxicity

Assessment:

For this endpoint no toxicological test data is available for the whole product.

11.1.8 Specific target organ toxicity (single exposure)

Assessment:

For this endpoint no toxicological test data is available for the whole product.



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11.1.9 Specific target organ toxicity (repeated exposure)

Assessment:

For this endpoint no toxicological test data is available for the whole product.

11.1.10 Aspiration hazard

Assessment:

Based on the physical-chemical properties of the product no aspiration hazard must be expected.

11.1.11 Further toxicological information

By handling the product for many years no damage to health was observed.

SECTION 12: Ecological information

12.1 Toxicity

Assessment:

No expected damaging effects to aquatic organisms. According to current knowledge adverse effects on water purification plants are not expected.

12.2 Persistence and degradability

Assessment:

Insoluble in water. Separation by sedimentation.

12.3 Bioaccumulative potential

Assessment:

No adverse effects expected.

12.4 Mobility in soil

Assessment:

Insoluble in water.

12.5 Results of PBT and vPvB assessment

This product contains no relevant substances considered to be persistent, bioaccumulative and toxic (PBT) or very persistent and very bioaccumulative (vPvB).

12.6 Other adverse effects

none known

SECTION 13: Disposal considerations

13.1 Waste treatment methods

13.1.1 Material

Recommendation:

Observe local/state/federal regulations.

13.1.2 Uncleaned packaging

Recommendation:

Completely discharge containers (no tear drops, no powder rest, scraped carefully). Empty containers should be sent to an approved recycling facility.

13.1.3 Waste Disposal Legislation Ref.No.(EC)

It is not possible to determine a waste code for this product in accordance with the European Waste Catalogue (EWC) since it is only possible to classify it according to how it is used by the customer. The waste code is to be determined within the EU in liaison



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with the waste-disposal operator.

SECTION 14: Transport information

14.1 – 14.4 UN number; UN proper shipping name; Transport hazard class(es); Packing group

	Road ADR: Valuation:	Not regulated for transport
	Railway RID: Valuation	Not regulated for transport
	Transport by sea IMDG-Code: Valuation	Not regulated for transport
	Air transport ICAO-TI/IATA-DGR: Valuation	Not regulated for transport
14.5	Environmental hazards	

Hazardous to the environment: no

14.6 Special precautions for user

Relevant information in other sections has to be considered.

14.7 Transport in bulk according to Annex II of MARPOL and the IBC Code

Bulk transport in tankers is not intended.

SECTION 15: Regulatory information

15.1 Safety, health and environmental regulations/legislation specific for the substance or mixture

National and local regulations must be observed.

For information on labelling please refer to section 2 of this document.

Directive 2012/18/EU of the European Parliament and of the Council on the control of major-accident hazards involving dangerous substances (Seveso III):

Not applicable

Other specifications, restrictions and prohibitions:

Regulation (EC) No 649/2012 of the European Parliament and the Council concerning the export and import of dangerous chemicals: Not applicable

15.2 Chemical safety assessment

For this product, a chemical safety assessment according to (EC) regulation 1907/2006 (REACH) has been carried out.

15.3 Details of international registration status

Relevant information about individual substance inventories, where available, is given below.

Japan	: ENCS (Handbook of Existing and New Chemical Substances):
	This product is listed in, or complies with, the substance inventory.
Australia	: AICS (Australian Inventory of Chemical Substances):
	This product is listed in, or complies with, the substance inventory.
China	: IECSC (Inventory of Existing Chemical Substances in China):
	This product is listed in, or complies with, the substance inventory.
Canada	: DSL (Domestic Substance List):
	This product is listed in, or complies with, the substance inventory.
Philippines	PICCS (Philippine Inventory of Chemicals and Chemical Substances):
	This product is listed in, or complies with, the substance inventory.



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United States of America (US	United States of America (USA): TSCA (Toxic Substance Control Act Chemical Substance Inventor All components of this product are listed as active or are in compl substance inventory.		
European Economic Area (E	General note: the registration obligation manufactured within the EEA by the su	: REACH (Regulation (EC) No 1907/2006): General note: the registration obligations for substances imported into the EEA or manufactured within the EEA by the supplier mentioned in section 1 are fulfilled by the said supplier. The registration obligations for substances imported into the EEA	
South Korea (Republic of Ko	by customers or other downstream us ea): AREC (Act on Registration and Evalua	ers must be fulfilled by the latter.	

SECTION 16: Other information

16.1 Material

The details in this document are based on the state of our knowledge at the time of revision. They do not constitute an assurance of the described product properties in terms of statutory warranty requirements.

The providing of this document to a recipient does not relieve the recipient of his or her responsibility toward compliance with all laws and stipulations applicable to the product. This applies in particular to the further sale or distribution of the product or substances or items containing the product, in other jurisdictions and with regard to the protection of third-party intellectual property rights. If the described product is processed or mixed with other substances or materials, the details stated in this document cannot be conferred to the resultant new product unless this has been expressly mentioned. If the product is repackaged, the recipient is obligated to additionally provide the required safety-related information.

16.2 Further information:

Commas appearing in numerical data denote a decimal point. Vertical lines in the left-hand margin indicate changes compared with the previous version. This version supersedes all previous versions.

- End of Safety Data Sheet -